



Page 1 of 10

DIODES, POWER RECTIFIER, SCHOTTKY BARRIER

BASED ON TYPE STP6H0100

ESCC Detail Specification No. S106/019

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Administrative/General Notes

(Refer to specifications for ESCC 0001 series)

Item No.	General Description
101	Administrative/General Notes for ESCC 0001 series.



TABLE OF CONTENTS

1	<u>GENERAL</u>	1
1.1	Scope	1
1.2	Applicable Documents	1
1.3	Terms, Definitions, Abbreviations, Symbols and Units	1
1.4	The ESCC Component Number and Component Type Variants	1
1.4.1	The ESCC Component Number	1
1.4.2	Component Type Variants	1
1.5	Maximum Ratings	1
1.6	Handling/Precautions	1
1.7	Physical Dimensions and Terminal Identification	7
1.7.1	Mini Range Mount Package (SMD) – 8 Lead	7
1.7.2	Surface Mount Package (SMD) – 4 Terminal	8
1.7.3	Notes to Physical Dimensions and Terminal Identification	8
1.8	Functional Diagram	8
1.9	Materials and Finishes	8
2	<u>MECHANICAL</u>	11
2.1	General	11
2.1.1	Exclusions from the General Specification	11
2.1.1.1	Exclusions from Screening Tests – Draw P1	11
2.1.1.2	Exclusions from Qualification and Potable Tests – Draw P1	11
2.2	Soldering	11
2.3	Terminal Strength	11
2.4	Electrical Measurements at Room, High and Low Temperatures	11
2.4.1	Room Temperature Electrical Measurements	11
2.4.2	High and Low Temperature Electrical Measurements	11
2.4.3	Notes to Electrical Measurement Tables	11
2.5	Power-on I/O Values	12
2.6	Interruptions and Shut-Point Electrical Measurements	12
2.7	Power-on/Off Conditions	12
2.8	Operating Life Conditions	12
APPENDIX A		13



5. GENERAL

5.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type. Values within the range of components specified below. It supplements the requirements of associated test used in conjunction with, the ESCC General Specification (not under duplicate numbers).

5.2 APPLICABLE DOCUMENTS

The following documents form part of the specification and shall be used in conjunction with it:

- (a) ESCC General Specification No. 0000
- (b) MIL-STD-200, Test Methods and Procedures for Semiconductor Devices

5.3 SYMBOLS, ABBREVIATIONS, DIMENSIONS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Seal Specification No. 010001 shall apply.

5.4 THE ESCC COMPONENT NUMBER AND COMPONENT TEST SYMBOLS

5.4.1 The ESCC Component Number

The ESCC Component Number shall be constructed as follows:

Example: 010019A

- a - Seal Specification Reference: 010019
- b - Component Type Variant Number (if applicable)

5.4.2 Component Test Symbols

The component type variant applications this specification are as follows:

Variant Number	Seal test Type	Lead	Cathode Cathode Terminal	Lead Terminal Electrical LeadPitch	Weight (max g)
01	ESPlastic	10,254	0	193	1.0
02	ESPlastic	10,254	1	193	1.0
03	ESPlastic	10,254	0	193	1

The mechanical material and finish shall be in accordance with the requirements of ESCC Seal Specification No. 010001.

5.5 MAXIMUM RATINGS

The maximum ratings shall not be exceeded at any time during use or storage.



Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Seal Specification.

Characteristic	Symbol	Maximum Rating	Unit	Reference
Permeable Gas Content (per Decade)	V_{max}	100	μl	Table 1
Permeable Fuel Vapor Content (ppm)	V_{max}	100	μl	Table 2
Permeable Fuel Vapor Content	V_{max}	1	μl	Table 3
Average Water Vapor Transmission	W_v		μl	Specialty Config. Tables 4, 5
Volume OH, @ 100000 (per Decade)		20		
Volume OH, @ 10000 (per Decade)		50		
Moisture Vapor Transmission (per Decade)	V_{max}	10	μl	
Operating Temperature Range (Glass Temperature)	T_{op}	-55 to +175	°C	Table 6
Storage Temperature	T_s	-55 to 175	°C	
Storage Temperature Range	T_{op}	-55 to +175	°C	Table 6
Operating Temperature	T_{op}		°C	
For TIG-204		±100		Table 6
For 020019		±100		Table 7
Concentration of Inert Gases (vol. %)	wt%	100%	%	
Permeation Resistance (relative to Gas)	R_{max}		μm	Tables 8, 9
Volume OH and O ₂ (per Decade)		1.0		
Volume OH and O ₂ (per Decade)		1.0		
Volume O ₂ (per Decade)		1.0		
Volume O ₂ (per Decade)		100		

NOTES:

1. Maximum value of time duration.
2. Fuel, aviation keros, kerosene.
3. Fuel, aviation keros, kerosene.
4. For Volume OH and O₂ at T_{max} is +100°C per Decade and T_{max} is +100°C per Decade, denote linearly to fit at +100°C. For Volume OH at T_{max} is +100°C per Decade and T_{max} is +100°C per Decade, denote linearly to fit at +100°C.
5. Permeations without externally humidified air being performed at T_{max} is +100°C and the correction is a 100% linear assumption.
6. Specifier to specify location area: distance of not less than 1.5mm from the device body and the gaseous (equal or to the equivalent) humidity, have stipulated.
7. Specifier to specify maximum and the same package shall not be available until humidity have stopped.
8. Package mounted on PCB is permitted.
9. The per Decade ratings apply only when both seals terminals are tied together.

**6.6 usage and installation**

The ESCC package contains: Resilient O-ring (RO) and therefore it must not be ground, machined, sandblasted or subjected to any mechanical operations which will produce stress. The resin must not be subjected to any chemical process (e.g. welding) which will produce fumes.

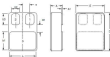
6.7 packaging, transportation and installation instructions

Consignment forms are given following the case drawings and dimensions.

6.8 Mounting Case / Mounting Case of ESCC - 1 case

Symbol	Dimensions, mm		Notes
	Min	Max	
a	1.000	1.000	
b	1.000	1.000	
c	20.00	20.00	
d	10.0	10.0	
e	0	1.000	
20'	10.0	10.0	
22	1.000	1.7.0	
23	0.000 BSC		
24	0.000	1.000	2
25	1.000 BSC		
26	1.000 BSC		
27	1.000	14.0	
28'	0.000 (Optional)		2

Symbol	Dimensions mm		Notes
	Min	Max	
W	-	0.25	2
W1	-	0	3, 4
W2	+0.05 Typical		3, 4

4.24 Radial Mount Profiles (RMPs) - 2 Terminals


Symbol	Dimensions mm		Notes
	Min	Max	
a	0.0	0.00	
d1	0.25	0.25	
d	0.0	0.00	
h1	0.000	0.000	
h2	0.00	0.00	1
h3	0.00	0.00	1
h4	0.25	0.25	
h5	0.0	-	1
h	0.0	0.00	
h	±0.002		1

4.24 How to Identify Dimensions and Terminal Identifications

1. The terminal identification is specified by the component's geometry. See the Function/Diagram for the terminal connections.
2. 1: plated.
3. 2: Nickel.



6. Systems

6.1 Electronics Packages



Notes:

1. For TO-18, the pins are connected in any lead.
2. For SMDs, the list is non-connectable as specified.

6.2 Mounting & Solder Preforms

Mounting and Solder shall be as follows:

- 4) Case
For the metal flange mount package the case shall be hermetically sealed and have a metal body. The leads pass through ceramic supports mounted into the frame and the lid shall be sealed.
For the surface mount package the case shall be hermetically sealed and have a ceramic body with a Kovar lid.
- 4) Leads/Terminals
As specified in Component Type Variants.



2. REQUIREMENTS

2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Basic Specification, formerly agreed with specific manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

2.1.1 Deviations from the Generic Specification

2.1.1.1 Deviations from Drawing Exam. - Class P1

(a) High Temperature Reverse Bias Burn-in and the subsequent Final measurements for HTRB shall be omitted.

2.1.1.2 Deviations from Qualification and Periodic Tests - Class P1

- (a) Constant Acceleration shall be omitted.
- (b) For ESD/Terminal Strength is nonapplicable.

2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 070010 and as follows:

The information to be marked on the component shall be:

- (a) Trade ESCC qualified components: symbol for ESCC qualified components only;
- (b) Trade ESCC Component Number;
- (c) Traceability Information;
- (d) Raytheon Contracting Agency (CADA) only;

2.3 PERFORMANCE CHARACTERISTICS

The recommendations for terminal strength, stated as specified in the ESCC Generic Specification, shall be as follows:

For T1-24, Test Condition 4, remains, with an applied force of 10N for a duration of 10s.

2.4 PERFORMANCE AND RELIABILITY TEST PROCEDURES AND TEST CONDITIONS

Electrical measurements shall be performed at room, high and low temperatures. Consultation thereof are given after the name.

**2.4.1 Room Temperature Electrical Measurements**The measurements shall be performed at $T_{amb} = 20 \pm 0.5^\circ\text{C}$.

Characteristic	Symbol	Reference Test Method	Test Conditions Notes 1	Units		Units
				Min	Max	
Reverse Current	I_{RR}	ANSI	DC Method $V_{RR} = 1000\text{V}$	-	10	μA
	I_{RR}	ANSI	DC Method $V_{RR} = 1000\text{V}$	-	5	μA
Forward Voltage	V_{FR}	ANSI	DC Method 1.0A Note 2	-	100	mV
	V_{FR}	ANSI	DC Method 1.0A Note 2	-	100	mV
	V_{FR}	ANSI	DC Method 1.0A Note 2	-	100	mV
Capacitance	C_j	ANSI	$V_{FR} = 1000\text{V}$ 1.0A	-	1	pF
Thermal Impedance	$\theta_{JC(jc)}$	ANSI	Junction to case 1.0A 1.0A $I_{FR} = 1000\text{mA}$ Note 3	(Calculation) see Note 4)		$^\circ\text{C/W}$

2.4.2 High and Low Temperature Electrical Measurements

Characteristic	Symbol	Symbol, Unit, Ref Test Method	Test Conditions Notes 1, 2	Units		Units
				Min	Max	
Reverse Current	I_{RR}	ANSI	$T_{amb} = 100^\circ\text{C}$ or 200°C DC Method $V_{RR} = 1000\text{V}$	-	10	μA
	I_{RR}	ANSI	$T_{amb} = 100^\circ\text{C}$ or 200°C DC Method $V_{RR} = 1000\text{V}$	-	5.0	μA



Characteristics	Symbol	Type, Unit, Test Method	Test Conditions Notes: Test 1:	Limits		Units
				Min	Max	
Nominal Voltage	V_{nom}	100 V	$T_{amb} = 20 \pm 0.5^\circ\text{C}$ Pulse Method q) valid Note 2	-	100	V _{rms}
			$T_{amb} = 40 \pm 0.5^\circ\text{C}$ Pulse Method q) valid Note 2	-	100	V _{rms}
			$T_{amb} = 100 \pm 0.5^\circ\text{C}$ Pulse Method q) valid Note 2	-	100	V _{rms}

2.4.2 Notes on Electrical Measurement Testing

- Measurements per each state.
- Pulse Width/Width: Duty Cycle/PC.
- Performant only during (downing) Tests Parameter: Both Values (Initial Measurements for TMB), 1000-10.
- Test limits for (a), shall be defined by the Manufacturer necessary for it accordance with MIL-STD-750 Method (a) or equivalent guarantee the $R_{th(j-c)}$ limits specified in Maximum Ratings.
- Final and several measurements shall be performed on sample of 5 components with 2 failures allowed. Alternatively a 100% inspection may be performed.

2.4.3 PARAMETER SHIFT VALUES

Unless otherwise specified, the measurements shall be performed at $T_{amb} = 100 \pm 0.5^\circ\text{C}$.

The test methods and test conditions shall be as per the corresponding test defined in Final Temperature Electrical Measurements.

The shift values (a) shall not be considered for each characteristic specified. The corresponding absolute test values for each characteristic shall not be exceeded.

Characteristics	Symbol	Limits		Units	
		Test Value (a)	Min/Max		
			Min		Max
Maximum Current I	I_{max}	100 100% 100%	-	100	A _{rms}
Nominal Voltage I	V_{nom}	100	-	100	V _{rms}

**NOTE**

1. ΔT_{max} is the greater referred to the total value.

2.6 TEMPERATURE AND HUMIDITY ELECTRICAL CHARACTERISTICS

Unless otherwise specified, the measurements shall be performed at $T_{\text{amb}}=25 \pm 0.5^{\circ}\text{C}$.

The test methods and test conditions shall be as per the corresponding test defined in IEC 60747-1:2003 Temperature Electrical Measurements.

The test values for each characteristic shall not be exceeded.

Characteristic	Symbol	Limits		Units
		Min	Max	
Reverse Current	I_{R}	-	500	μA
	I_{R1}	-	5	μA
Forward Voltage	V_{F1}	-	1.050	V
	V_{F2}	-	1.650	V
	V_{F3}	-	2.000	V

2.7 POWER RATING CONDITIONS

Characteristic	Symbol	Test condition	Value
Power Dissipation	P_{max}	25°C	100
Reverse Voltage	V_{R}	50	V

2.8 OTHER TESTS AND CONDITIONS

The conditions shall be as specified for Power Rating.



APPENDIX

GENERAL CONDITIONS FOR PURCHASE CONTRACTS

ITEM NUMBER	DESCRIPTION OF CONDITIONS
Condition Item Production - General - Class F1	General EC Production Item - General Class F1 general. Budget items require 1. extra dimensions are acceptable for handling with a 2.0 mm gap.
Condition Item Sawing Term... Class F1	Condition's responsibility when operating. Agreement to the Contract Date.